

T2035H Series

Snubberless™ high temperature 20 A Triacs

Main features

Symbol	Value	Unit
I _{T(RMS)}	20	Α
V _{DRM} /V _{RRM}	600	V
I _{GT (Q1)}	35	mA
T _{j MAX}	150	°C

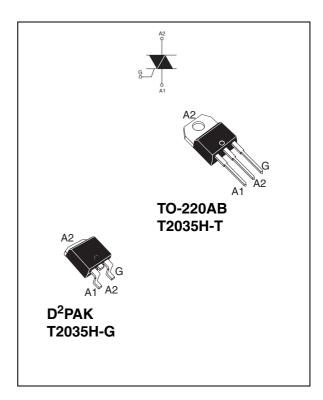
Description

Specifically designed to operate at 150° C, the new 20 A T2035H Triacs provide an enhanced performance in terms of power loss and thermal dissipation. This facilitates the optimization of heatsink dimensioning, leading to improved space and cost effectiveness when compared to electromechanical solutions.

Based on ST SnubberlessTM technology, the T2035H series offers high commutation switching capabilities and high noise immunity levels on the full range of T_i .

The T2035H series facilitates the optimization of the control of universal motors and inductive loads found in appliances such as vacuum cleaners, and washing machines.

The T2035H Triacs are also suitable for use in high temperature environment found in hot appliances such as cookers, ovens, hobs, electric heaters, and coffee machines.



Order code

Part number	Marking
T2035H-600G	T2035H-600G
T2035H-600G-TR	T2035H-600G
T2035H-600TRG	T2035H-600T

TM: Snubberless is a trademark of STMicroelectronics

July 2006 Rev 1 1/10

Characteristics T2035H Series

1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Parameter				Unit
I _{T(RMS)}	RMS on-state current (full sine wave)		T _c = 127° C	20	Α
1 .	Non repetitive surge peak on-state current	F = 60 Hz	t = 16.7 ms	210	Α
ITSM	(full cycle sine wave, T _j initial = 25° C)	F = 50 Hz	t = 20 ms	200	
l²t	I2t Value for fusing	tp = 1	0 ms	283	A ² s
dl/dt	Critical rate of rise of on-state current $I_G = 2xI_{GT}$, tr \leq 100 ns		T _j = 125° C	50	A/µs
V _{DSM} /V _{RSM}	Non repetitive surge peak off state voltage		T _j = 25° C	700	V
I _{GM}	Peak gate current $t_p = 20 \mu s$		T _j = 150° C	4	Α
P _{G(AV)}	Average gate power dissipation $T_j = 150^{\circ} \text{ C}$				W
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			-40 to +150 -30 to +150	°C
T _I	Maximum leads soldering temperature during 10 s			260	°C

Table 2. Electrical characteristics ($T_i = 25^{\circ}$ C, unless otherwise specified)

Symbol	Test conditions Quadrant			Value	Unit
I _{GT} ⁽¹⁾	V 10 V D 22 O	1 - 11 - 111	MAX	35	mA
V _{GT}	$-V_D = 12 \text{ V, R}_L = 33 \Omega$	I - II - III	MAX	1.3	V
V_{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega, T_j = 150^{\circ} \text{ C}$ I - II - III		MIN	0.15	V
I _H ⁽²⁾	I _T = 100 mA		MAX	35	mA
1	1 10 11		MAX	50	mA
I_L $I_G = 1.2 \times$	$I_G = 1.2 \times I_{GT}$	II	IVIAA	80	
dV/dt (2)	$V_D = 67\% V_{DRM}$, gate open, $T_j = 150^{\circ} C$		MIN	300	V/µs
(dl/dt)c (2)	Without snubber, T _j = 150° C		MIN	8.9	A/ms

^{1.} minimum I_{GT} is guaranteed at 5% of I_{GT} max

577

^{2.} for both polarities of A2 referenced to A1

T2035H Series Characteristics

Table 3. Static electrical characteristics

Symbol	Test conditions			Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 28 A, t _p = 380 μs	Tj = 25° C	MAX	1.5	V
V _{TO} ⁽¹⁾		Tj = 150° C	MAX	0.80	V
R _D ⁽¹⁾		Tj = 150° C	MAX	21	mΩ
		Tj = 25° C		5	μΑ
I _{DRM} I _{RRM}	$V_{DRM} = V_{RRM}$	Tj = 150° C	MAX	7.4	mA
'RRIVI	V _D /V _R = 400 V (at peak mains voltage)	Tj = 150° C		4.8	IIIA

^{1.} for both polarities of A2 referenced to A1

Table 4. Thermal resistance

Symbol	Parameter			Value	Unit
R _{th (j-c)}	Junction to case for full (AC)		D ² PAK TO-220AB	1	
D	Junction to ambient	S = 1 cm ²	D ² PAK	45	°C/W
R _{th (j-a)}	Junction to ambient		TO-220AB	60	

Figure 1. Maximum power dissipation vs RMS on-state current (full cycle)

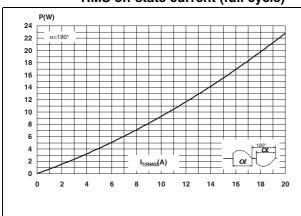
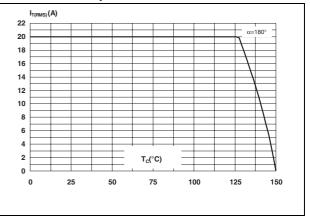


Figure 2. RMS on-state current versus case temperature



Characteristics T2035H Series

Figure 3. RMS on-state current vs ambient temperature (epoxy printed circuit board FR4 e_{cu} = 35 μ m)

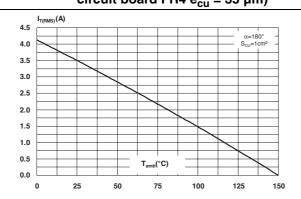


Figure 4. Relative variation of thermal impedance vs pulse duration

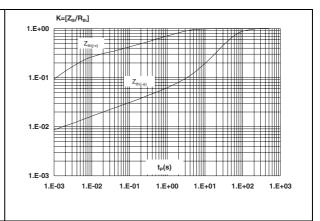


Figure 5. On-state characteristics (maximum values)

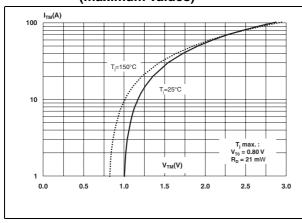


Figure 6. Surge peak on-state current vs number of cycles

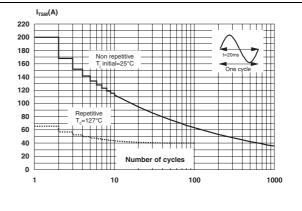
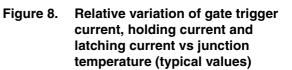
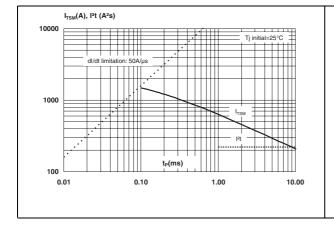
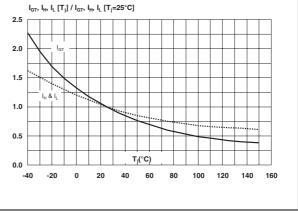


Figure 7. Non repetitive surge peak on-state current (sinusoidal pulse width tp<10 ms) and value of I²t







4/10

T2035H Series Characteristics

Figure 9. Relative variation of critical rate of decrease of main current (di/dt)c vs reapplied (dV/dt)c

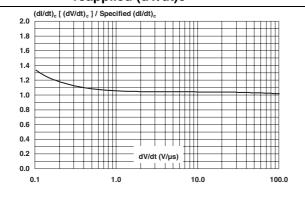


Figure 10. Relative variation of critical rate of decrease of main current (di/dt)c versus junction temperature

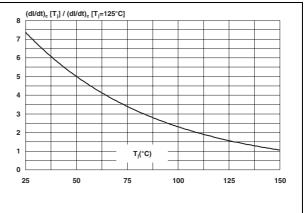


Figure 11. Leakage current versus junction temperature for different values of blocking voltage (typical values)

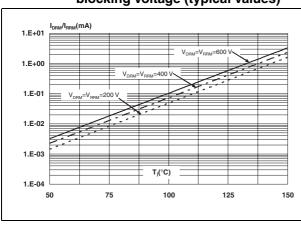


Figure 12. Acceptable repetitive peak off-state voltage versus case-ambient thermal resistance

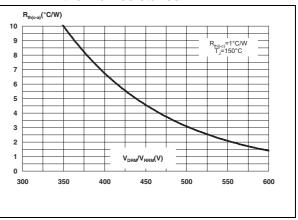
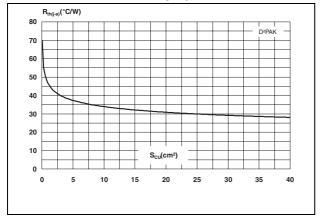
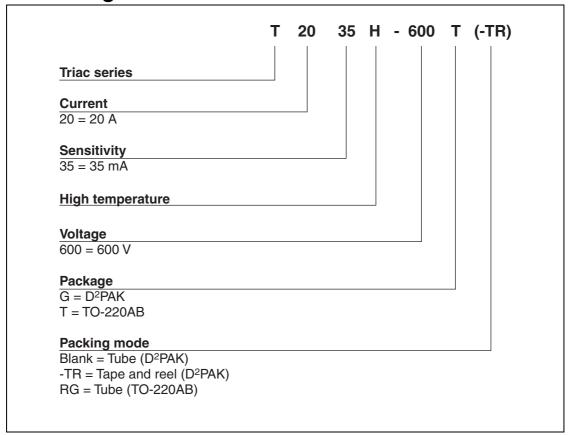


Figure 13. D²PAK junction to ambient thermal resistance versus copper surface under tab (PCB FR4, copper thickness 35 μm)



2 Ordering information scheme



T2035H Series Package information

3 Package information

Table 5. TO-220AB dimensions

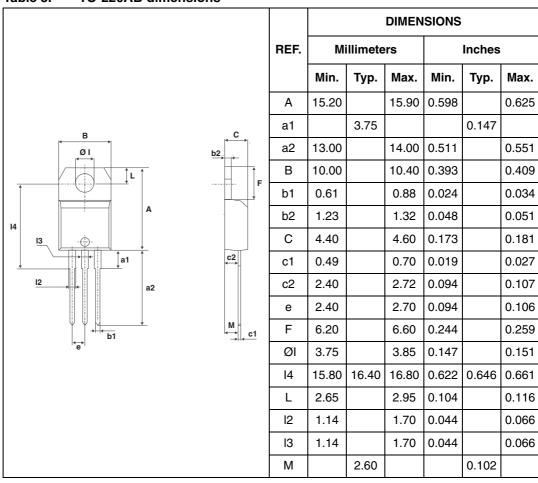
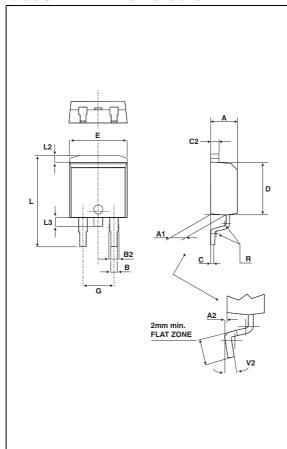
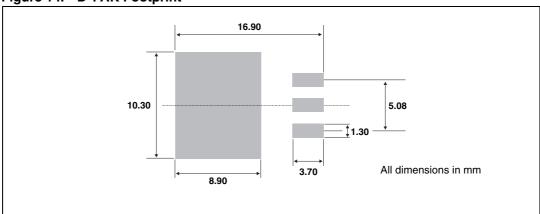


Table 6. D²PAK dimensions



	DIMENSIONS			
REF.	Millimeters		Inc	hes
	Min.	Max.	Min.	Max.
Α	4.40	4.60	0.173	0.181
A1	2.49	2.69	0.098	0.106
A2	0.03	0.23	0.001	0.009
В	0.70	0.93	0.027	0.037
B2	1.14	1.70	0.045	0.067
С	0.45	0.60	0.017	0.024
C2	1.23	1.36	0.048	0.054
D	8.95	9.35	0.352	0.368
Е	10.00	10.40	0.393	0.409
G	4.88	5.28	0.192	0.208
L	15.00	15.85	0.590	0.624
L2	1.27	1.40	0.050	0.055
L3	1.40	1.75	0.055	0.069
М	2.40	3.20	0.094	0.126
R	0.40 typ.		0.016	6 typ.
V2	0°	8°	0°	8°

Figure 14. D²PAK Footprint



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

8/10

T2035H Series

Ordering information

4 Ordering information

Part number	Marking	Package	Weight	Base Qty	Packing mode
T2035H-600G	T2035H-600G	D ² PAK	1.5 g	50	Tube
T2035H-600G-TR	T2035H-600G	D ² PAK	1.5 g	1000	Tape and Reel
T2035H-600TRG	T2035H-600T	TO-220AB	2.3 g	50	Tube

5 Revision history

Date	Revision	Changes
13-Jul-2006	1	Initial release.

577

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

